

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|----|------|-------|--------|----------------------|-----------------------|---------------------|
| 13 | BRS | L13 | 378841 | molding | USPAT; EPO; JPO | 2001/06/30 22:42 |
| 14 | BRS | L14 | 5542 | encapsulant | USPAT; EPO; JPO | 2001/06/30 22:43 |
| 15 | BRS | L15 | 1061 | 257/738 | USPAT; EPO; JPO | 2001/06/30 22:45 |
| 16 | BRS | L16 | 0 | 7 and 8 and 9 and 10 | USPAT; EPO; JPO | 2001/06/30 22:46 |
| 17 | BRS | L17 | 0 | 7 and 8 and 9 | USPAT; EPO; JPO | 2001/06/30 22:46 |
| 18 | BRS | L18 | 9939 | 5 and 6 | USPAT; EPO; JPO | 2001/06/30 22:46 |
| 19 | BRS | L19 ✓ | 11 | 7 and 14 | USPAT; EPO; JPO | 2001/06/30 22:46 |
| 20 | BRS | L20 | 2063 | 8 and 10 | USPAT; EPO; JPO | 2001/06/30 22:46 |
| 21 | BRS | L21 ✓ | 35 | 5 and 6 and 8 and 10 | USPAT; EPO; JPO | 2001/06/30 22:47 |
| 22 | BRS | L22 | 124 | 1 and 18 | USPAT; EPO; JPO | 2001/06/30 22:47 |
| 23 | BRS | L23 ✓ | 2 | 1 and 20 X | USPAT; EPO; JPO | 2001/06/30 22:47 |
| 24 | BRS | L24 ✓ | 52 | 1 and 14 and 18 | USPAT; EPO; JPO | 2001/06/30 22:49 |

09/475,104

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|----|------|------|--------|---|-----------------------|---------------------|
| 1 | BRS | L1 | 6902 | flip adj chip | USPAT; EPO; JPO | 2001/06/30 22:38 |
| 2 | BRS | L2 ✓ | 1 | organic adj flip adj chip - 5,535,526 | USPAT; EPO; JPO | 2001/06/30 22:38 |
| 3 | BRS | L3 ✓ | 2 | high adj performance adj thermal adj interface - 5,535,526 | USPAT; EPO; JPO | 2001/06/30 22:39 |
| 4 | BRS | L4 | 0 | high adj performance adj thermal adj interface adj curing adj process | USPAT; EPO; JPO | 2001/06/30 22:39 |
| 5 | BRS | L5 | 9939 | curing adj process | USPAT; EPO; JPO | 2001/06/30 22:39 |
| 6 | BRS | L6 | 169220 | curing | USPAT; EPO; JPO | 2001/06/30 22:39 |
| 7 | BRS | L7 | 160 | thermal adj epoxy | USPAT; EPO; JPO | 2001/06/30 22:40 |
| 8 | BRS | L8 | 10870 | microwave adj energy | USPAT; EPO; JPO | 2001/06/30 22:41 |
| 9 | BRS | L9 | 1904 | thermal adj element | USPAT; EPO; JPO | 2001/06/30 22:40 |
| 10 | BRS | L10 | 7807 | microwave adj frequency | USPAT; EPO; JPO | 2001/06/30 22:41 |
| 11 | BRS | L11 | 5749 | solder adj ball | USPAT; EPO; JPO | 2001/06/30 22:42 |
| 12 | BRS | L12 | 766341 | mounting | USPAT; EPO; JPO | 2001/06/30 22:42 |

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|----|------|-----|------|--|-----------------------|---------------------|
| 25 | BRS | L25 | ✓1 | 7 and 9 X | USPAT; EPO; JPO | 2001/06/30 22:50 |
| 26 | BRS | L26 | ? 79 | 1 and 11 and 12 and 13 and 14 | USPAT; EPO; JPO | 2001/06/30 22:50 |
| 27 | BRS | L27 | ✓6 | 1 and 11 and 12 and 13 and 14 and 18 - 5,923,934 - 5,827,949 | USPAT; EPO; JPO | 2001/06/30 22:51 |

L26

* 6,245,545
- 6,238,949
- 6,236,588
- 6,227,206
* 6,214,642
* 6,011,694
* 5,811,312
* 900,675
* 891,753
* 5,872,051

L24

- 6,168,972
+ 6,121,689
- 5,817,545
- 5,629,566
- 5,583,378
- 5,525,545

L21

X

L19

- 5,895,967